# **SMD** Power Inductor

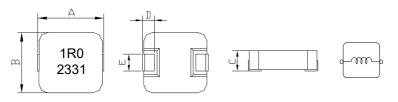
#### 1. Features

- 1. Low loss realized with low DCR.
- 2. High performance realized by metal dust core.
- 3. Ultra low buzz noise, due to composite construction.
- 4. 100% Lead(Pb)-Free and RoHS compliant.
- 5. Operating temperature:-40~+150 $^{\circ}$ C (Including self temperature rise)

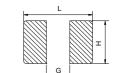
# 2. Applications

Commercial applications

#### 3. Dimension



Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)
TMPV1044FC	10.2±0.4	10.2±0.4	4.0±0.4	2.4±0.4	3.0±0.4



**Recommend PC Board Pattern** 

L(mm)	G(mm)	H(mm)		
13.5	5.4	4.1		
Note: 1.PCB layout is referred to standard IPC-7351B				

 The above PCB layout reference only.
Recommend solder paste thickness at 0.15mm and above.

### 4. Part Numbering

TMPV	<b>1044</b>	FC -	1 <b>R0</b>	MN	- 2R5910	- JDX	
А	В	С	D	Е	F	G	
A: Series							
B: Dimension		BxC					
C: Material		F: Lead F	ree, C: Curi	e TAF200	material.		
D: Inductance		1R0=1.00uH					
E: Inductance To	olerance	M=±20%					
F: DCR							
G: Control S/N		Marking	Black.1R0 a	and 2331(	23 YY,31 WW,follow	production date)	

# 5. Specification

Part Number	Inductance L0 (uH)±20%	l rms(A) Typ	I sat(A) Typ	DCR(mΩ) ±10%
TMPV1044FC-1R0MN-2R5910-JDX	1.00	24.2	22.5	2.59
TMPV1044FC-1R3MN-2R5910-JDX	1.30	24.2	22.5	2.59
TMPV1044FC-2R2MN-4R4510-JDX	2.20	16.6	11.5	4.45

Note:

1. Test frequency : Ls : 100KHz /0.25V.

- 2. All test data referenced to 25  $^\circ\!\mathrm{C}$   $\,$  ambient.
- 3. Testing Instrument(or equ) : Agilent 4284A, E4991A, 4339B, KEYSIGHT E4980A/AL, chroma3302, 3250, 16502.
- 4. Heat Rated Current (Irms) will cause the coil temperature rise approximately  $\ {\rm \Delta T}$  of 40  $^{\circ}{\rm C}$
- 5. Saturation Current (Isat) will cause L0 to drop approximately 30%.

6. The part temperature (ambient + temp rise) should not exceed 150°C under worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

7. Irms Testing : Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

8. Rated DC current: The lower value of Irms and Isat.

9. Curie TAF200 material.

10. Voltage Rated: 20V

TMPV1044FC-Series(N)-JDX

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# Hangen RoHS

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